HOW TO APPROACH SCANNING ELECTRON MICROSCOPY AND ENERGY DISPERSIVE SPECTROSCOPY ANALYSIS

SCSAM Short Course Amir Avishai

RESEARCH QUESTIONS



Cast Iron EDS+SE

> Objective Ability to ask the right questions!

Sea Shell





50nm Cu Vias



First Order Lamellar Interface



CHARACTERIZATION IS PART OF THE EXPERIMENT!









Amir Avishai

Dr. Wayne Jennings

"POKE AND LISTEN"



Source/Beam/Probe \rightarrow Interaction/Signal \rightarrow Detector \rightarrow Data Interpretation / *Contrast mechanisms*

LIGHT VS SEM / TEM



Based on Abbe's theory you cannot resolve structure below about 1/2 the wavelength of the probe.



Visible light ≅ 400-700nm



 $\delta = \frac{0.61\lambda}{\mu\sin\beta}$

Resolution

Notes: 1nm=1000pm, typical atomic spacing $\approx 0.1nm$

wavelength

OUTLINE

- Beam optics and image formation.

- Signals Generated in an SEM and their detection.
- Beam energy & current.
- EDS compositional analysis.
- What else can we do with an SEM?
- How do we approach a new sample?

BASIC OPERATION MODE OF SEM

Nova 200 Nano-Lab



Electron Vacuum Gun Chamber Anode Condenser Lens Electron Beam Condenser Lens Objective Lens Chamber Detector

Schematic diagram illustrating the essential components of an SEM. Note that an array of useful signals can be collected and analyzed by use of different detectors.

How Scanning Electron Microscopes Work

IMAGE FORMATION IN SEM



CORALS – VERY LARGE DEPTH OF FIELD



200 µm

Acc.V Spot Magn Det WD 20.0 kV 3.5 250x SE 18.9 Amir Avishai 200 µm

200 m

Spot Magn 4.0 150x

20.0 kV 4.0







Amir Avishai

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WHAT TYPE SIGNALS ARE CREATED IN A SEM?



DETECTORS AVAILABLE

- Everhart Thornley (ETD) Detector (SE, BSE)
- InLens(TLD) Detector SE, BSE Detection
- ▶ ICE Detector (SE, BSE, ions)
- Retractable STEM Detector (BF, DF, HAADF)
- Retractable Solid state BSE Detector
- GSED SE Detection
- EDS Photon Detection and Energy Analysis
- EBSD Backscattered Electron Diffraction

Beam Deceleration



CHARACTERISTICS OF SECONDARY AND BSE ELECTRONS

Energy distribution of all electrons emitted from specimen under keV electron bombardment: SE: Topographic BSE: Compositional



By definition, these secondary electrons are <50 eV, with most 3-5 eV.

ELECTRON BEAM PENETRATION



SURFACE IMAGING – TOPOGRAPHY, CRYSTAL SYMMETRY





BACKSCATTER ELECTRON PRODUCTION

Mo, Si, O





Electron Back-Scattered Diffraction Patterns (EBSD) Orientation Imaging Mapping (OIM)



DETECTOR POSITION & CONTRAST

Deweting of Ni Film over Sapphire

SE Image





Where is the detector?

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BSE VS SE AND VOLTAGE





Acc.V Spot Magn Det WD Exp 30.0 kV 5.5 4000x BSE 12.8 0 Hivac





Amir Avishai

BEAM ENERGY AND PENETRATION





5 kV

25 kV

BIOLOGICAL TISSUE IMAGING





Critical point dried Rods in a Wild Mouse Eye Debarshi Mustafi cwru. som

Brain Tissue Grahame Kidd CCF

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COMPOSITIONAL INFORMATION – ENERGY DISPERSIVE SPECTROSCOPY (EDS)



X-RAY GENERATION VOLUME

- Atomic number correction (Z)
- > Absorption correction (A)
- Characteristic fluorescence correction (F)

$$R_{\chi} = \frac{0.064}{\rho} (E_0^{1.68} - E_C^{1.68}) \qquad \begin{array}{l} \mathsf{R}_{\chi} - [\mu \mathsf{m}] \\ \mathsf{E}_0 - [\mathsf{Ke}] \\ \mathsf{E}_{\mathsf{C}} - [\mathsf{Ke}] \\ \mathsf{e}_0 - \mathsf{g}/\mathsf{cm} \end{array}$$

Cu K



 $\frac{20 \text{ keV}}{F}$ $\frac{20 \text{ keV}}{F}$ $\frac{1}{F}$ $\frac{1}{F$

REQUIRED CONDITIONS FOR EDS ANALYSIS

- Polished sample (flat).
- Measure on a uniform region.
- No etching, use BSE to identify phases.
- Use a beam energy 2-3 times the highest peak analyzed.
- For charging samples avoid metallic coatings if possible, use carbon.
- Repeat measurement in a few locations.







Specimen must be Homogenous over x-ray generation volume for correct answer

IDENTIFYING ELEMENTS & OVERLAPPING PEAKS

- Never trust auto ID, confirm every peak.
- In case of severe overlaps use higher energies to confirm elements.
- Use longer processing time to better resolve peaks or long collection times (better statistics).





Failure Analysis - Device



COMMON ARTIFACTS & ERRORS DURING ANALYSIS

- ► Sum/pileup Peaks
- ► Si X-Ray Escape peaks
- Errors due to charging (Duane-Hunt limit).
- Background removal in elemental maps.
- ► Working distance
- ► Magnification.







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VPSEM CAPABILITIES

- Conventional High Vacuum
 - Coated/conductive specimens
 - Critical point dried specimens
- ► Low Vacuum or Wet Mode
 - Charge reduction for non-conductors
 - Surface imaging in a gas (hydration/dehydration, oxidation studies)
 - Vacuum sensitive materials (biological samples)
 - ► Wet or "dirty" specimens (ESEM)
 - I. Working Distance
 - II. Gas Pressure
 - III. Accelerating Voltage

HIGH TEMPERATURE HYDRATION-LILY POLLEN



FRESH LACCARIA (TREE FUNGUS) IN AN ESEM



STEM IN SEM: MULTIPLE SIGNALS COLLECTED SIMULTANEOUSLY

Mark DeGuire CWRU



The user has not direct control over the "camera length"

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WHAT IS OUR PARAMETER SPACE?

- ► Beam Energy
- ▶ Beam Current
- ► Working Distance (WD)
- Sample/Stage Tilt and rotation
- ► Type of signals
- ► Type of Detector
- Detector setup
- ► No immersion, Immersion mode
- Scan strategies (slow scan, integrate, average, line average/interlace)
- ► Stage Bias
- Scan Rotation
- Sample mounting

RESEARCH QUESTIONS



HFW curr mag ⊪ WD 17,1 um 0,40 nA 15 000 x 4,1 mm

2.00 kV

Cast Iron EDS+SE Fe Cr C



50nm Cu Vias

Image showing detail of axons and myelin sheaths, Mitochondria.



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